



COMPONENT WEIGHT - 1.8 GMS

NOTE: (1) All dimensions are in mm. (2) Tolerance for all dimension is (± 0.2) (3) Molding Material: (a) Deralin				 DURGA ELECTRONICS(INDIA)	
				COMPONENT NAME: BOBBIN	
REMARKS:				REV. 00	
DESIGN BY	SACHIDANAND	SIGN.		DATE	28.07.05
CHECKED BY	MANOJ GUPTA			DATE	28.07.05
APPR. BY	MANOJ GUPTA			DATE	28.07.05
SCALE: NTS		DRG. NO: DEI/DRG/0295		PATH	